

2N65

Power MOSFET

2A, 650V N-CHANNEL POWER MOSFET

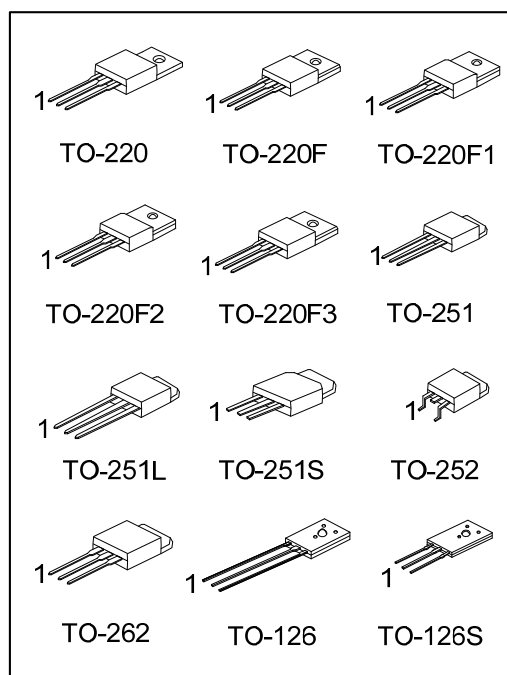
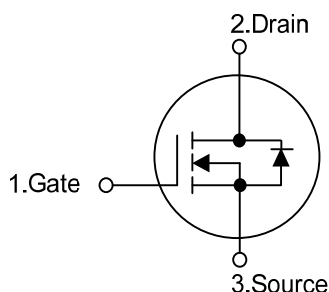
DESCRIPTION

The **2N65** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)} < 5.0\Omega$ @ $V_{GS} = 10V$
- * Ultra Low gate charge (typical 45nC)
- * Low reverse transfer capacitance (C_{RSS} = typical 9 pF)
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

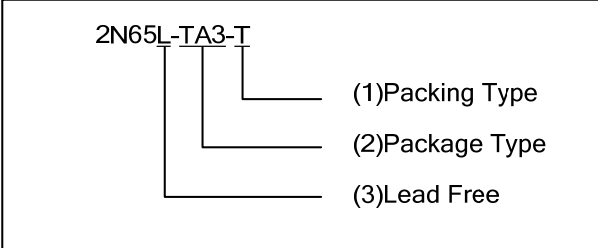
SYMBOL



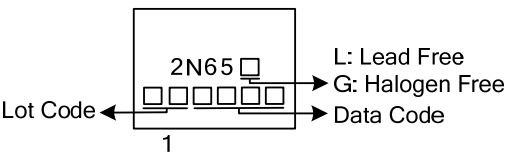
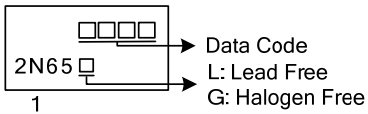
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
2N65L-TA3-T	2N65G-TA3-T	TO-220	G	D	S	Tube
2N65L-TF1-T	2N65G-TF1-T	TO-220F1	G	D	S	Tube
2N65L-TF2-T	2N65G-TF2-T	TO-220F2	G	D	S	Tube
2N65L-TF3-T	2N65G-TF3-T	TO-220F	G	D	S	Tube
2N65L-TF3T-T	2N65G-TF3T-T	TO-220F3	G	D	S	Tube
2N65L-TM3-T	2N65G-TM3-T	TO-251	G	D	S	Tube
2N65L-TMA-T	2N65G-TMA-T	TO-251L	G	D	S	Tube
2N65L-TMS-T	2N65G-TMS-T	TO-251S	G	D	S	Tube
2N65L-TN3-R	2N65G-TN3-R	TO-252	G	D	S	Tape Reel
2N65L-TN3-T	2N65G-TN3-T	TO-252	G	D	S	Tube
2N65L-T2Q-T	2N65G-T2Q-T	TO-262	G	D	S	Tube
2N65L-T60-K	2N65G-T60-K	TO-126	G	D	S	Bulk
2N65L-T6C-K	2N65G-T6C-K	TO-126C	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source

	(1) T: Tube, R: Tape Reel, K: Bulk (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, TF3T: TO-220F3, TM3: TO-251, TMA: TO-251L, TMS: TO-251S, TN3: TO-252, T2Q: TO-262, T60: TO-126, T6C: TO-126C (3) L: Lead Free, G: Halogen Free
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MARKING INFORMATION

PACKAGE		MARKING
TO-220 TO-220F TO-220F1 TO-220F2 TO-220F3	TO-251 TO-251L TO-251S TO-252 TO-262	
TO-126 TO-126C		

■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	± 30	V
Avalanche Current (Note 2)		I_{AR}	2.0	A
Drain Current	Continuous	I_D	2.0	A
	Pulsed (Note 2)	I_{DM}	8.0	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	140	mJ
	Repetitive (Note 2)	E_{AR}	4.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220/TO-262	P_D	40	W
	TO-220F/TO-220F1 TO-220F3		21	W
	TO-220F2		23	W
	TO-251/TO-251L TO-252/TO-251S		28	W
	TO-126/TO-126C		12.5	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Operating Temperature		T_{OPR}	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by T_J .

3. $L=64\text{mH}$, $I_{AS}=2.0\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD}\leq 2.4\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/ TO-262 TO-220F/TO-220F1 TO-220F2/TO-220F3	θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
	TO-251/TO-251L TO-252/TO-251S		110	$^\circ\text{C}/\text{W}$
	TO-126/TO-126C		132	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220/ TO-262	θ_{JC}	3.13	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1 TO-220F3		5.95	$^\circ\text{C}/\text{W}$
	TO-220F2		5.43	$^\circ\text{C}/\text{W}$
	TO-251/TO-251L TO-251S/TO-252		4.53	$^\circ\text{C}/\text{W}$
	TO-126/TO-126C		10	$^\circ\text{C}/\text{W}$

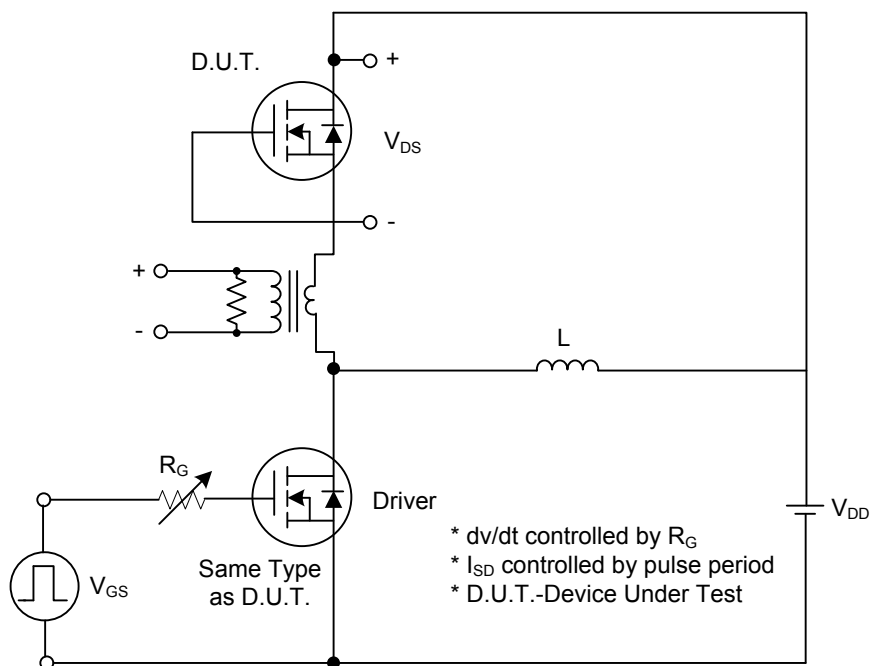
■ ELECTRICAL CHARACTERISTICS ($T_J=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0V, I _D = 250μA	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 650V, V _{GS} = 0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} = 30V, V _{DS} = 0V			100	nA
	Reverse		V _{GS} = -30V, V _{DS} = 0V			-100	nA
Breakdown Voltage Temperature Coefficient		ΔBV _{DSS} /ΔT _J	I _D =250μA, Referenced to 25°C		0.4		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D =1A		3.9	5.0	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f =1MHz		320	370	pF
Output Capacitance		C _{OSS}			40	50	pF
Reverse Transfer Capacitance		C _{RSS}			9	12	pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time		t _{D (ON)}	V _{DD} =325V, I _D =2.4A, R _G =25Ω (Note 1, 2)		35	50	ns
Turn-On Rise Time		t _R			40	60	ns
Turn-Off Delay Time		t _{D (OFF)}			130	160	ns
Turn-Off Fall Time		t _F			40	60	ns
Total Gate Charge		Q _G	V _{DS} =520V, V _{GS} =10V, I _D =2.4A (Note 1, 2)		45	55	nC
Gate-Source Charge		Q _{GS}			4		nC
Gate-Drain Charge		Q _{GD}			8.4		nC
DRAIN-SOURCE DIODE CHARACTERISTICS							
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} = 0 V, I _{SD} = 2.0 A			1.4	V
Continuous Drain-Source Current		I _{SD}				2.0	A
Pulsed Drain-Source Current		I _{SM}				8.0	A
Reverse Recovery Time		t _{rr}	V _{GS} = 0 V, I _{SD} = 2.4A,		180		ns
Reverse Recovery Charge		Q _{RR}	di/dt = 100 A/μs (Note1)		0.72		μC

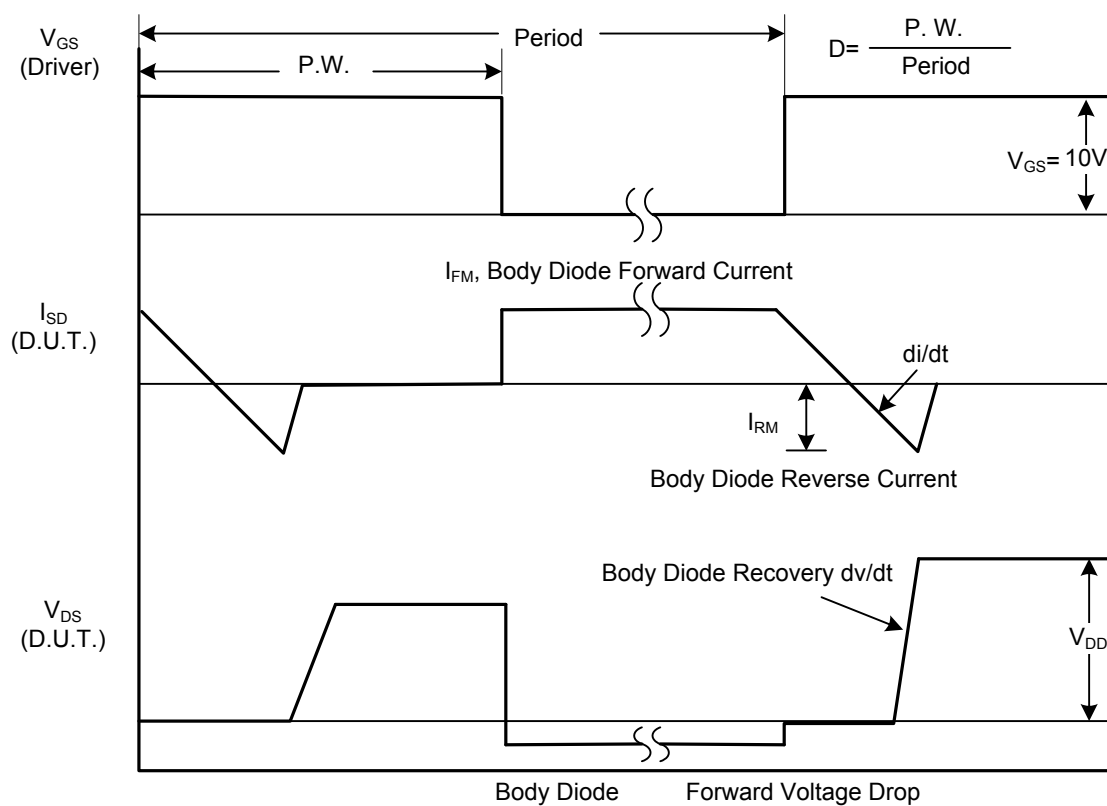
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

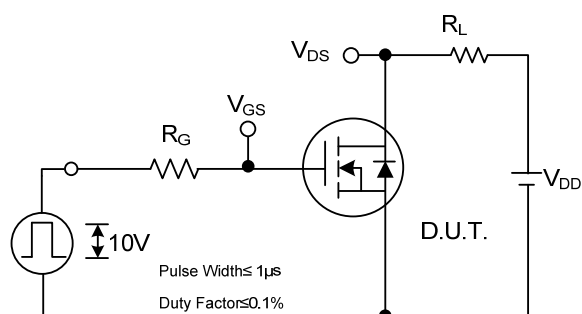


Peak Diode Recovery dv/dt Test Circuit

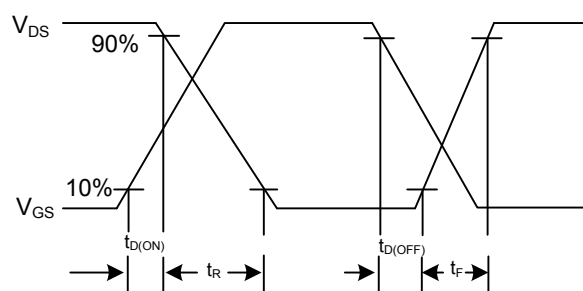


Peak Diode Recovery dv/dt Waveforms

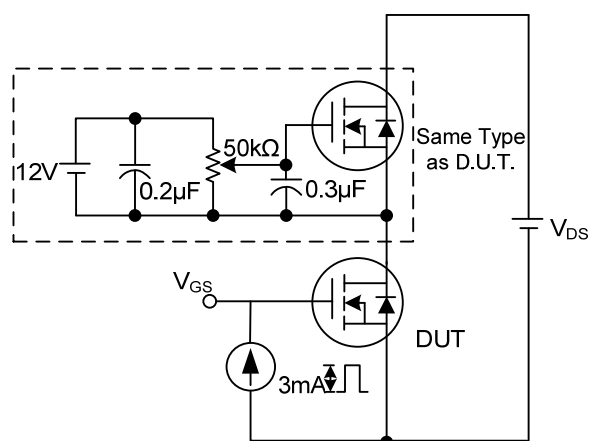
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



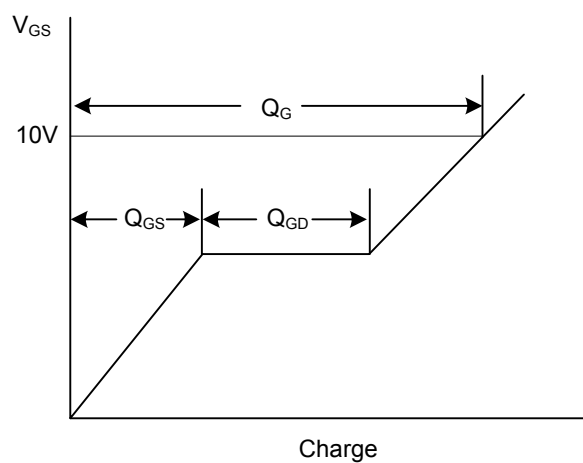
Switching Test Circuit



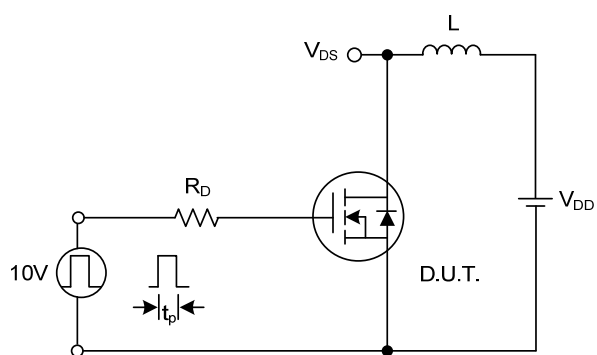
Switching Waveforms



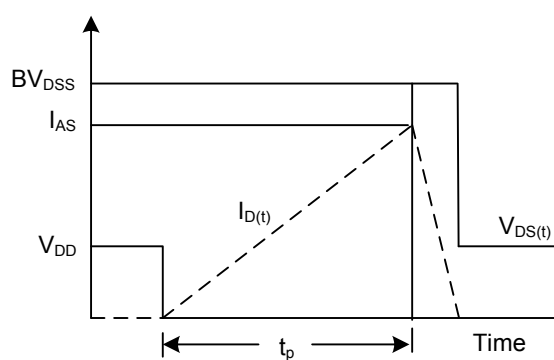
Gate Charge Test Circuit



Gate Charge Waveform

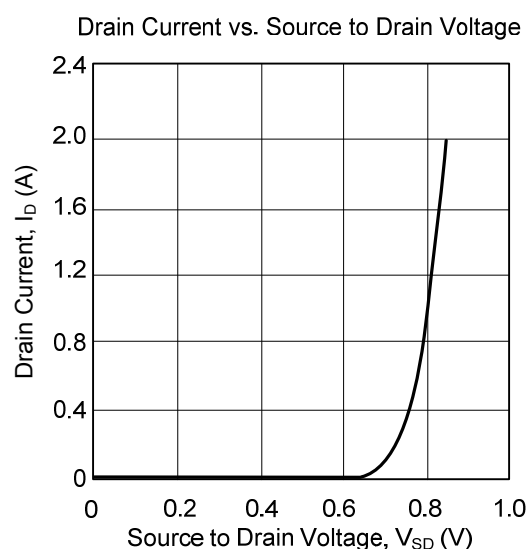
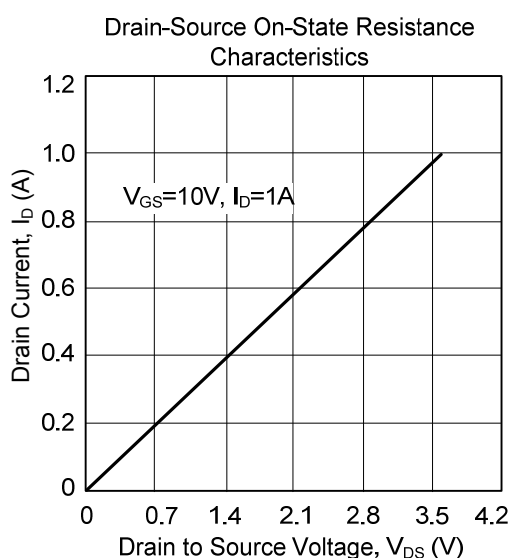
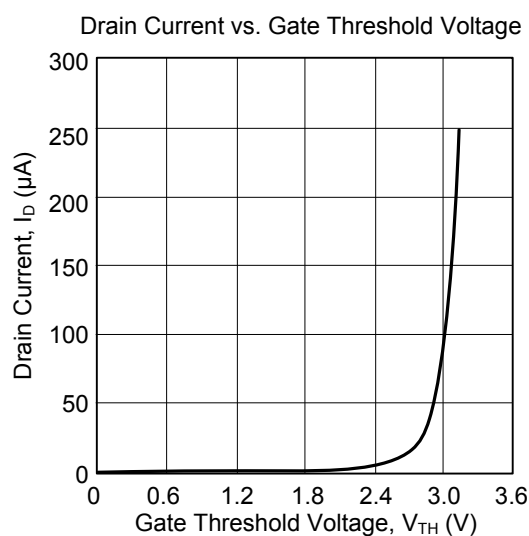
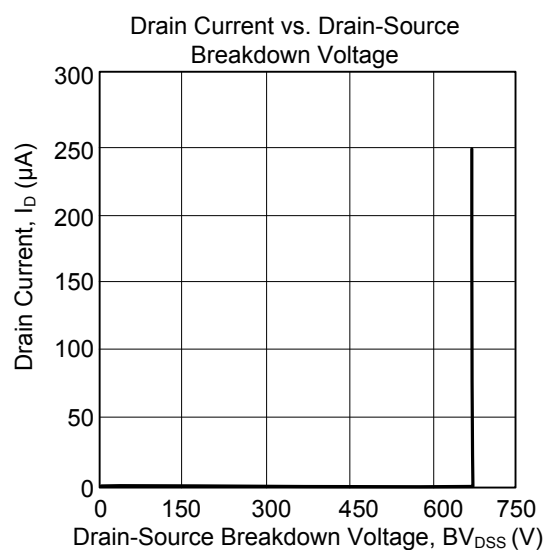


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



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